

Product Specification [产品规格书]:	ISSUED BY:	ISSUED BY: Engineering Dept Date Issued 2021/05/10		
	Date Issued	2021/05/10		
Subject [主题]: 1.00mm Pitch 1038 Series Connector Specification	Date Revised	2024/07/06		
1.00mm Filen 1036 Series Connector Specification	Version	B1		

This specification is referred to the 1.00mm series wire to board connector

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【1.适用范围 Scope】

此种规格包括 1.00mm Pitch 1038 Series 连接器规格说明.

This Specification Covers the 1.00mm Pitch 1038 Series Connector Specification.

【2.规格与料号 Spec and Part number】

规格内容	产品料号
Specification	Production No.
端子/Terminal	1038T-PXX
胶壳/Housing	1038H-2*XX-N0HF
针座/Wafer	1038WVS-2*XX-4TXX 1038WRS-2*XX-4TXX

【3.材质与表面处理 Disposal of Material and surface】

规格内容		材 质	表面处理
Specification		Materials	Disposal of Surface
端子/Terminal		磷铜/Phosphor Bronze	Gold Flash or 15u"Min . Nickel: Over 30μ"
胶壳/Housing PA66 UL 94V-0		UL 94V-0	
	Base	PA4T	UL 94V-0
针座/Wafer	PIN	磷铜/Phosphor Bronze	Gold Flash or 15u" Min ; Over 50μ″ Nickel
	Solder tab	黄铜/Brass	Over Matte Tin 100µ″ Plated Over 50µ″ Nickel

(上述参数请以工程图为准/Please Refer to the Project drawing for the above Specification)

【4. 额定等级 Ratings and applicable wires】

项 目【Item】	规 格【Standard】		
额定电压 Rated Voltage (Max.)	50V	[AC/DC]	
额定电流 Rated Current (Max.)	1A		
使用温度范围 Ambient temperature Range	-40°C~+105°C		
适用线径 Applicable wire insulation O.D	AWG 28#、30#、32# Insulation O.D. 0.80mm(Max.)		

【*升温时含端子.Including terminal temperature rise. 】

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【5.性能 PERFORMANCE】

5-1. 电气的性能 Electrical Performance.

	项 目	条 件	规格
	[Item]	【Test Condition】	[Requirement]
5-1-1	接触阻抗 Contact Resistance	公母配合,开放电压 20mV 以下,电流 10mA 检测连接器 A~B 区. Mate connectors, measure by dry circuit, 20mV MAX, 10mA. (Based upon EIA-364-06A).	Initial: 20 milliohms Max. After Test: 40 milliohms Max.
5-1-2	绝缘阻抗 Insulation Resistance	公母配合,在相邻端子,端子与地片之间,使用 500V 的直流电,检测连接器. Mate connectors, apply 500V DC between adjacent terminal or ground. (Based upon EIA-364-21B / MIL-STD-202 Method 302 Cond.B)	
5-1-3	耐电压 Dielectric Strength	公母配合,在相邻端子,端子与地片之间,使用 250V 的交流电 1 分锺, 检测连接器. Mate connectors, apply 250V AC for 1 minute between adjacent terminal or ground. (Based upon EIA-364-20A / MIL-STD-202 Method 301)	不出现中断等情况 No Breakdown and Flashover
5-1-4		铆线后之端子,开放电压 20mV 以下,电流 10mA 检测连接器. Crimp the applicable wire on to the terminal measure by dry circuit 20mV MAX, 10mA.	10 milliohms Max.



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5-2. 机械的性能 Mechanical Performance.

	项 目 【Item】	条 件 【Test Condition】	规 格 【Requirement】
5-2-1	插拔力 Insertion & withdraw Force	以每分锺 25.4±3mm 的速率插入和拔出. Insert and withdraw Connectors at the speed rate of 25.4±3mm/minute.	参照第 6 项 Refer to paragraph 6
5-2-2	端子保持力 Terminal/ Housing Retention Force	以每分 25.4±3mm 的速率,将端子从 Housing 内轴向拔出的力量. Apply axial pull out force at the speed rate of 25.4±3mm/minute on the terminal assembled in the housing.	4.90N {0.5kgf} Min.
5-2-3	端子插入力 Terminal Insertion Force	铆线后的端子插入 Housing 所需最大力量. Insert the crimped terminal into the housing.	4.9N {0.5kgf} Max.
5-2-4	Pin 针保持力 Pin Retention Force	以每分 25.4±3mm 的速率,将 PIN 针从 Wafer 内轴向拔出的力量. Apply axial push force at the speed rate of 25.4±3mm/minute.	2.94N {0.30kgf} Min.

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	项 目	条 件	规	7	各	
	[Item]	[Test Condition]	[Requirement]			
			AWG#	#28	#30	#32
5-2-5	端子压着强度 Tensile strength (Crimped connections)	固定铆线后的端子,使电线与端子分离时所需的最小力量. Fix the crimped terminal, apply axial pull out force on the wire. (Do not crimp insulation part).	Spec.kgf. Min.	1.0	0.5	0.3
		Contact Wire Pulling load	this specification define values w			
5-2-6	卡扣保持力 Retention force of buckle	配对连接器,并以 25+3mm/分钟的速度施加轴向拔出力. Mated connectors , and apply axial pull out force at the speed rate of 25 + 3mm / minute.	19.6N {2kgf} Min.			

<u>5-3. 环境性能及其它 Environmental Performance and Others.</u>

项 目		条件	规	格	
[Item]		[Test Condition]	[Requirement]		
5-3-1	重复插拔 Repeated Insertion/ Withdrawal	以每分锺不超过 10 次的速率,将公母插拔 30 次. When mated up to 30 cycles repeatedly by the rate of 10 cycles per minute.	接触阻抗 Contact Resistance	40 milliohms Max.	
5-3-2	温升测试 Temperature Rise	公母对插后,在通过额定电流下,所测定的温度. Carrying rated current load. (UL 1977)	温升测试 Temperature rise	30°C Max.	
5-3-3	振动测试 Vibration test	振幅: 1.5mm P-P 时间: 10~55~10 HZ in 1 minute 持续时间: 每轴向 2 小时 Amplitude: 1.5mm P-P Sweep time: 10~55~10 HZ in 1 minute Duration: 2 hours in each X.Y.Z axes. (Based upon EIA-364-28B/MIL-STD-202 Method 213B Cond.A)	外观 Appearance	无异状 No Damage	
			接触阻抗 Contact Resistance	40 milliohms Max.	
			瞬断 Discontinuity	1 microsecond Max.	

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				外观	
				Appearance	No Damage
	5-3-4	冲击测试	在 X.Y.Z 上 6 个方向上,以 490m/s²(50g 的力量)冲击下各-3 回.490m/s²(50G), 3 strokes in each X.Y.Z. axes.	接触阻抗	
				Contact	40 milliohms Max.
		Shock test	(Based upon EIA-364-27B/MIL-STD-202 Method 213B Cond.A)	Resistance	
			Cond.rxy	瞬断	1 microsecond Max.
				Discontinuity	
				外观	无异状
		武劫州	105±2°€,96 hours.	Appearance	No Damage
	5-3-5	耐热性 Heat Resistance	(Based upon MIL-STD-202 Method 108A Cond.A)	接触阻抗	
			(Based upon MIL-STD-202 Method 108A Cond.A)	Contact	40 milliohms Max.
				Resistance	40 milliohms Max. 无异状 No Damage
				外观	No Damage 40 milliohms Max. 无异状
		耐寒性	-40±5°⊂,96 hours.	Appearance	
	5-3-6	Cold Resistance	(Based upon EIA-364-105)	接触阻抗	
				Contact	
				Resistance 外观	
			温度: 40±2℃	Appearance	
			湿度: 90~95%(RH)	接触阻抗	40 milliohms Max.
			持续时间: 96 hours	Contact	
	5-3-7	耐湿性	Temperature: 40±2°C	Resistance	
		Humidity	Relative Humidity: 90~95%	耐电压 Dielectric	
			Duration: 96 hours	Strength	
			(Based upon EIA-364-31A/MIL-STD-202 Method 103B	绝缘阻抗 Insulation	100 Megohms Min
			Cond.B)	Resistance	100 Flegorinis Film.
			II 4000 H /+ 20 // FF/II T : 40500 H /+ 20 // FF /II T F /-	外观	无异状
		温度变化 Temperature	从-40℃持续 30 分锺升至+105℃持续 30 分锺,循环 5 次. 5 cycles of: a) -40°C 30 minutes.	Appearance	No Damage
	5-3-8		b) +105°C 30 minutes.	接触阻抗	
		Cycling	(Based upon EIA-364-32B)	Contact	1 microsecond Max. 无异状 No Damage 40 milliohms Max. 无异状 No Damage 40 milliohms Max. 无异状 No Damage 40 milliohms Max. 100 Megohms Min. 无异状
			,	Resistance	
			在温度 35±2℃ ,盐水浓度 5±1% 下,盐水喷雾 48±1 小时.	外观	
		七小時便	48±1 hours exposure to a salt spray from the 5±1%	Appearance	No Damage
	5-3-9	盐水喷雾 Salt Spray	solution at 35±2°C.	接触阻抗	
		Juic Spray	(Based upon EIA-364-26B/MIL-STD-202 Method 101D	ypan FIA 264 26P/MIL CTD 202 Mathad 101D	40 milliohms Max.
			Cond.B).	Resistance	
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5-3-10	焊锡附着性 Solder-ability	焊接时间: 3~5 秒. 焊接温度: 245±5℃. Soldering Time: 3~5second. Solder Temperature: 245±5℃. (Based upon EIA-364-52)	Solder Wetting	浸渍面积需 95%以上 95% of immersed area must show no voids, pin holes.
5-3-11	焊锡耐热性 Solder-Resistance	焊接时间: 5~10 秒. 焊接温度: 255+5/-5℃. Soldering time:5~10 sec solder. Temperature:255+5/-5℃. (Based upon EIA-364-56A)	外观 Appearance	无异状 No Damage



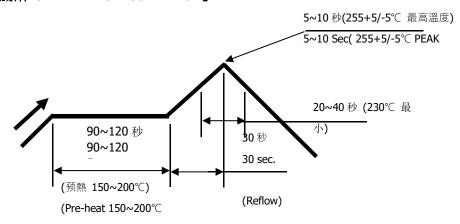
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【6.综合插入力及拔出力 INSERTION/WITHDRAWAL FORCE】 < Connector mating force >

PIN 数	初次插入力(最大值)	30 次拔出力(最小值)	PIN 数	初次插入力(最大值)	30 次拔出力(最小值)
No. of	First Insertion	30 th Withdrawal	No. of	First Insertion	30 th Withdrawal
CKT	(kgf Max.)	(kgf Min.)	CKT	(kgf Max.)	(kgf Min.)
2*08	2.40	0.30	2*15	4.50	0.50
2*10	3.00	0.35	2*20	6.00	0.60
2*12	3.60	0.40	2*25	7.50	0.80

注: 以上插拔次数为 30 次 Note: Insertion and Withdrawal for 30Cycles

【7. SMT 回流条件 SMT REFLOW CONDITION】



温度条件曲线图/ 基板上温度

TEMPERATURE CONDITION GRAPH/ (TEMPERATURE ON BOARD PATTERN SIDE)

注记:由于 P.C 板等焊接装置改变条件,所以请预先用自己的装置检查回流焊的条件.

Notes: Please check the reflow soldering condition by your own devices beforehand. Because the condition changes by the soldering devices, P.C. boards, and so on.